

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	6946	523/400.ccls. 523/440.ccls. 523/442.ccls. 523/443.ccls. 523/445.ccls. 523/457.ccls. 523/458.ccls. 523/459.ccls. 523/466.ccls. 523/468.ccls. 525/523.ccls. 525/529.ccls. 525/530.ccls. 525/533.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:01
L2	766725	((aluminum with (nitride oxide)) (boron adj2 nitride) silver (zinc with oxide) nanotube (nano adj tube) "nano-tube")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:02
L3	1192009	(silica (silicon with (oxide dioxide)) (titanium with (oxide dioxide)) alumina ((aluminum magnesium) with hydroxide) (calcium with carbonate))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:02
L4	518772	epox\$5 polyepox\$5 diepox\$5 ((glycidyl diglycidyl polyglycidyl) adj ether) diglycidyl\$ polyglycidyl\$	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:02
L5	288138	hardener curative (cross adj linker) crosslinker ((hardening curing (cross adj linking) crosslinking) adj2 (agent promoter))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:02
L6	23858	L4 and L5 and L2 and L3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:02
L7	1000	11 and 16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:03
L8	25781	halogenfree (free near2 halogen) "halogen-free" (non near5 (halogenated brominated chlorinated fluorinated))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:04
L9	47	17 and 18	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:04
L10	528180	particle adj2 (size diameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:05
L11	19	19 and 110	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:05

S1	0	jp-43006302-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 09:44
S2	0	jp-4306302-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 09:44
S3	1	jp-04306302-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 09:45
S4	0	jp-043006302-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 09:45
S5	8	suzuki-munehiko.in. suzuki-munehiko-\$.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 09:55
S6	217	kawamata-takeshi.in. kawamata-takeshi-\$.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 09:51
S7	223	hosokawa-etsuo.in. hosokawa-etsuo-4.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 09:51
S8	1171	munehiko	EPO; JPO; DERWENT	OR	ON	2005/08/17 09:52
S9	0	munehiko and trimellitimidides	EPO; JPO; DERWENT	OR	ON	2005/08/17 09:53
S10	0	munehiko and trimellitimide	EPO; JPO; DERWENT	OR	ON	2005/08/17 09:53
S11	56	trimellitimide	EPO; JPO; DERWENT	OR	ON	2005/08/17 10:15
S12	0	(S6 S7 S5) and trimellitimide	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 09:58
S13	518364	epox\$5 polyepox\$5 diepox\$5 ((glycidyl diglycidyl polyglycidyl) adj ether) diglycidyl\$ polyglycidyl\$	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:58
S14	11	(S6 S7 S5) and S13	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 09:58

S15	130	trimellitimide	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:16
S16	518364	epox\$ polyepox\$ diepox\$ ((glycidyl diglycidyl polyglycidyl) adj ether) diglycidyl\$ polyglycidyl\$	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:16
S17	26	S15 and S16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:24
S18	11960	diaminodiphenylmethane (diamino adj diphenylmethane) (diaminodiphenyl adj methane) (diamino adj diphenyl adj methane)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:20
S19	0	diaminodiphenylmethanetrimellitimide	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:20
S20	2	S18 with S15	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:20
S21	290753	"pcb" "pwb" (printed adj2 (circuit wiring) adj2 board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:08
S22	1	S17 and S21	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:28
S23	38268	S21 and S16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:29
S24	46795	heat adj2 (stable stability)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:03
S25	315	S23 and S24	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:29

S26	11273	halogenfree (free near2 halogen) "halogen-free"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:44
S27	14	S25 and S26	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:32
S28	315	S21 and S13 and S24	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:33
S29	1080940	silica (silicon adj2 (oxide dioxide)) (titanium adj2 (oxide dioxide)) alumina ((aluminum magnesium) adj2 hydroxide) (calcium adj2 carbonate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 12:57
S30	201	S28 and S29	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:38
S31	1672085	(aluminum adj2 (nitride oxide)) (boron adj2 nitride) silver aluminum (zinc adj2 oxide) nanotube (nano adj tube) "nano-tube"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 12:58
S32	175	S30 and S31	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:41
S33	94	S30 and S31 and conductive	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:42
S34	12	S33 and S16.ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 10:43
S35	130747	(heat thermal) adj2 (stable stability)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:58
S36	130	S13.ab. and S21.ab. and S35	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:04

S37	11	S36 and S29 and S31 and conductive	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:06
S38	10181	"fr-4" "fr 4" "fr4"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:06
S39	3752	S38 and S13 and S21	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:06
S40	6	S38 and S13 and S21 and (variable adj voltage)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:07
S41	25	S38 and S13 and S21 and (variable near2 voltage)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:16
S42	2232	(S38 with S16) and S21	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:17
S43	96897	S13 same (bisphenol cresol novolak novolac sma styrene styrenemaleic ppe polyphenylene polyphenyleneether)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:42
S44	498	S42 and S43	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:25
S45	79	S13 same (bisphenol) same (cresol novolak novolac) same (sma styrene styrenemaleic maleic) same (ppe phenylene polyphenylene polyphenyleneether)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:19
S46	6	S42 and S45	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:23
S47	6	S38 and S45	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:23

S48	2	(variable near2 voltage) and S45	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:24
S49	0	S13 and S21 and (variable near2 voltage) and S35 and conductive and S43	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:26
S50	0	S13 and S21 and (variable near2 voltage) and S35 and S43	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:26
S51	0	S13 and S21 and (variable near2 voltage) and S35 and S43	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:27
S52	624	S13 and S21 and S35 and S43	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:27
S53	0	S13 and S21 and S35 and S45	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:27
S54	832	S13 and S21 and S35 and conductive	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:27
S55	314	S13 and S21 and S35 and conductive and S43	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:28
S56	7389	S13.ab. and S21.ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:29
S57	2	S56 and S45	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:30
S58	1721	S56 and S43	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:30

S59	415746	(heat thermal) adj2 (stable stability resistance resistance resistiv\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:31
S60	523080	(heat thermal) near3 (stable stability resistance resistance resistiv\$5)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:31
S61	902	S58 and S60	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:32
S62	193	S61 and S29	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:32
S63	133	S61 and S29 and S31	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:34
S64	45	S61 and S29 and S31 and (conductive conductiv\$)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:42
S65	6	S61 and S29 and S31 and (conductive conductiv\$) and S26	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:37
S66	2836	S38 with S13	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:42
S67	141	S66 with (bisphenol cresol novolak novolac sma styrene styrenemaleic ppe polyphenylene polyphenyleneether)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:43
S68	182	S66 same (bisphenol cresol novolak novolac sma styrene styrenemaleic ppe polyphenylene polyphenyleneether)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:44
S69	25763	halogenfree (free near2 halogen) "halogen-free" (non near5 (halogenated brominated chlorinated fluorinated))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 12:56

S70	1093	S13 with S69	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:47
S71	288	S70 and S29 and S31	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:48
S72	168	S70 and S29 and S31 and S60	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:50
S73	63	S70 and S29 and S31 and S60 and conductive	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 11:50
S74	36	S70 and S29 and S31 and S60 and (conductive same (filler particle powder S31))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 12:46
S75	60	hsiao-ming.in. hsiao-ming-cheng.in. hsiao-ming-c.in. hsiao-ming-\$.in. hsiao-mingcheng.in. hsiao-mingcheng-\$.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 12:47
S76	10	chien-tai.in. chien-tai-wen.in. chien-tai-w.in. chien-tai-\$.in. chien-taiwen. in. chien-taiwen-\$.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 12:48
S77	25	wang-chang.in. wang-chang-yung.in. wang-chang-y.in. wang-chang-y.in. wang-changyung.in. wang-changyung-\$.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 12:49
S78	92	S75 S76 S77	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:23
S79	4	S13 and S78	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 12:55
S80	287936	hardener curative (cross adj linker) crosslinker ((hardening curing (cross adj linking) crosslinking) adj2 (agent promoter))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:59

S81	518364	epox\$5 polyepox\$5 diepox\$5 ((glycidyl diglycidyl polyglycidyl) adj ether) diglycidyl\$ polyglycidyl\$	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 12:56
S82	25763	halogenfree (free near2 halogen) "halogen-free" (non near5 (halogenated brominated chlorinated fluorinated))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:17
S83	287411	(silica (silicon with (oxide dioxide)) (titanium with (oxide dioxide)) alumina ((aluminum magnesium) with hydroxide) (calcium with carbonate)) with (filler particle powder)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:57
S84	177100	conductive with (filler particle powder (aluminum with (nitride oxide)) (boron adj2 nitride) silver aluminum (zinc with oxide) nanotube (nano adj tube) "nano-tube")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:13
S85	123	S80 and S81 and S82 and S83 and S84	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:14
S86	16	S85 and S21	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:01
S87	199867	(filler particle powder) with ((aluminum with (nitride oxide)) (boron adj2 nitride) silver aluminum (zinc with oxide) nanotube (nano adj tube) "nano-tube")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:39
S88	430	S80 and S81 and S82 and S83 and S87	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:39
S89	77	S80 and S81 and S82 and S83 and S87 and S21	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:14
S90	128568	(filler particle powder) with ((aluminum with (nitride oxide)) (boron adj2 nitride) silver (zinc with oxide) nanotube (nano adj tube) "nano-tube")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:57
S91	307	S80 and S81 and S82 and S83 and S90	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:50

S92	44	S80 and S81 and S82 and S83 and S90 and S21	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:49
S93	4859	(thermal thermally) with conductive with (filler powder)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:00
S94	47	S80 and S81 and S82 and S93	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:50
S95	22	S80 and S81 and S82 and S93 and S87	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:51
S96	22	S80 and S81 and S82 and S93 and S83	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:51
S97	19	S80 and S81 and S82 and S93 and S83 and S87	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:55
S98	3	S96 not S97	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:55
S99	766143	((aluminum with (nitride oxide)) (boron adj2 nitride) silver (zinc with oxide) nanotube (nano adj tube) "nano-tube")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:57
S100	1191079	(silica (silicon with (oxide dioxide)) (titanium with (oxide dioxide)) alumina ((aluminum magnesium) with hydroxide) (calcium with carbonate))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:58
S101	46	S94 and S99 and S100	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 13:58
S102	301130	"pcb" "pwb" (printed adj2 (circuit wiring) adj2 board) (copper adj clad) "copper-clad" (foil adj clad) "foil-clad" (metal adj clad) "metal-clad"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:29

S103	18131	S102 same S13	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:11
S104	3399	S103 and S80	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:11
S105	129	S104 and S93	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:12
S106	106	S104 and S93 and S99 and S100	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:13
S107	70	S104 and S93 and S99 and S100 and (particle adj2 (size diameter))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:33
S108	508	S93 same (particle adj2 (size diameter))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:34
S109	234	S13 and S108	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:34
S110	89	S13 and S108 and S102	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:34
S111	71	S13 and S108 and S102 and S80	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:35
S112	518364	epox\$5 polyepox\$5 diepox\$5 ((glycidyl diglycidyl polyglycidyl) adj ether) diglycidyl\$ polyglycidyl\$	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:44
S113	130747	(heat thermal) adj2 (stable stability)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:59

S114	2166	S112 with S113	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:59
S115	287936	hardener curative (cross adj linker) crosslinker ((hardening curing (cross adj linking) crosslinking) adj2 (agent promoter))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:45
S116	837	S114 and S115	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 14:59
S117	4859	(thermal thermally) with conductive with (filler powder)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:08
S118	15	S116 and S117	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:08
S119	50372	conductive with (filler powder)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:08
S120	36	S116 and S119	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:08
S121	21	S120 not S118	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:14
S122	2	(S115 with S113) and S112 and S119	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:16
S123	5263	thermal near2 interface	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:16
S124	58	S123 and S112 and S115 and S119	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:16

S125	25763	halogenfree (free near2 halogen) "halogen-free" (non near5 (halogenated brominated chlorinated fluorinated))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:04
S126	5	S124 and S125	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:21
S127	1093	S125 with S112	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:21
S128	8	S127 and S117	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:24
S129	60	hsiao-ming.in. hsiao-ming-cheng.in. hsiao-ming-c.in. hsiao-ming-\$.in. hsiao-mingcheng.in. hsiao-mingcheng-\$.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:23
S130	10	chien-tai.in. chien-tai-wen.in. chien-tai-w.in. chien-tai-\$.in. chien-taiwen. in. chien-taiwen-\$.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:23
S131	25	wang-chang.in. wang-chang-yung.in. wang-chang-y.in. wang-chang-y.in. wang-changyung.in. wang-changyung-\$.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:23
S132	92	S129 S130 S131	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:23
S133	23	S127 and S119	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:24
S134	301130	"pcb" "pwb" (printed adj2 (circuit wiring) adj2 board) (copper adj clad) "copper-clad" (foil adj clad) "foil-clad" (metal adj clad) "metal-clad"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:29
S135	16383	(S112.ab. and S134) (S134.ab. and S112)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:30

S136	3947	S135 and S115	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:30
S137	285	S136 and S119	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:31
S138	107616	inorganic with (filler powder)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:31
S139	86	S137 and S138	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:53
S140	3	S137 and S138 and S125	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:33
S141	9	S137 and S125	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:33
S142	2	us-20050137293-\$.did.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:57
S143	6153	(S112 same S113) (S112.ab. and S113.ab.)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 15:59
S144	527844	particle adj2 (size diameter)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:05
S145	864	S143 and S144	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:02
S146	766143	((aluminum with (nitride oxide)) (boron adj2 nitride) silver (zinc with oxide) nanotube (nano adj tube) "nano-tube")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/18 11:02

S147	1191079	(silica (silicon with (oxide dioxide)) (titanium with (oxide dioxide)) alumina ((aluminum magnesium) with hydroxide) (calcium with carbonate))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:02
S148	304	S143 and S144 and S146 and S147	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:03
S149	186	S143 and S144 and S146 and S147 and S115	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:08
S150	353	(halogen near2 free) and (phosphorus near2 free)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 17:12
S151	118	S150 and S112	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:36
S152	2	S150 and S117	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:36
S153	11257	(halogen near2 free)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:38
S154	409	S134 and S153 and S112	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:38
S155	34798	filler same (S144)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:38
S156	27	S154 and S155	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:44
S157	81646	flame adj2 (proof retardant retardent retard\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:44

S158	518364	epox\$5 polyepox\$5 diepox\$5 ((glycidyl diglycidyl polyglycidyl) adj ether) diglycidyl\$ polyglycidyl\$	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:44
S159	287936	hardener curative (cross adj linker) crosslinker ((hardening curing (cross adj linking) crosslinking) adj2 (agent promoter))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:45
S160	99002	(inorganic conductive) adj2 (filler powder additive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:46
S161	120125	(inorganic conductive) near3 (filler powder additive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:46
S162	2908	S157 and S158 and S159 and S161	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:47
S163	402	S157 and S158 and S159 and S161 and S113	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:48
S164	57	S157 and S158 and S159 and S161 and S113 and S125	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:49
S165	315	S157 and S158 and S159 and S161 and S125	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:48
S166	7924	S125.ab.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:50
S167	105	S162 and S166	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 16:50
S168	355	(halogen near2 (free devoid)) and (phosphorus near2 (free devoid))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 17:12

S169	119	S112 and S168	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 17:13
S170	25	S112 and S168 and S161	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/08/17 17:13